<u>MOSFET</u> – Power, Single N-Channel 60 V, 1.2 mΩ, 287 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C604NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

WAXIMOW RATINGS $(1) = 25$ C unless otherwise holed)					
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	I _D	287	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		203	1
Power Dissipation	State	T _C = 25°C	PD	200	W
R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		100	1
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	40	А
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		28	
Power Dissipation		T _A = 25°C	PD	3.9	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.9	1
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	203	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 22 A$)			E _{AS}	776	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

MAXIMUM RATINGS (T = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

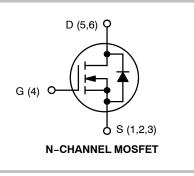
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

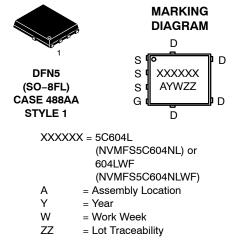


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.2 m Ω @ 10 V	007 4
00 V	1.7 mΩ @ 4.5 V	287 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

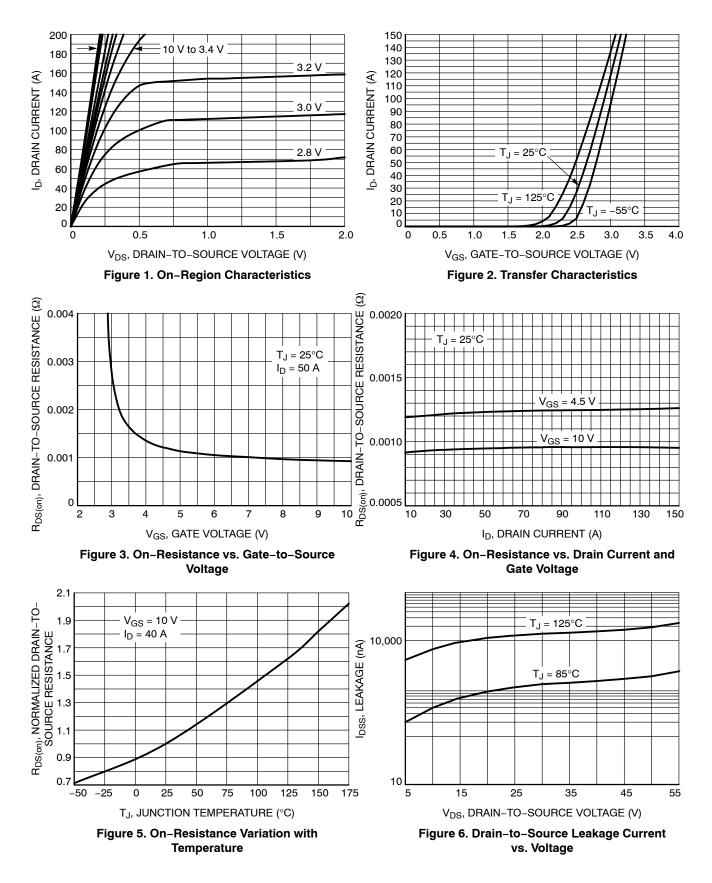
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS	•	•			-		•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				22.9		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			10		
		$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$				250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±16 V				±100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 250 μ A		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.9		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.93	1.2		
		V _{GS} = 4.5 V	I _D = 50 A		1.25	1.7	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			180		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}				8900			
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V		3750		pF	
Reverse Transfer Capacitance	C _{RSS}				40			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 50 A			52			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 50 A			120			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			6.4		nC V	
Gate-to-Source Charge	Q _{GS}				21.4			
Gate-to-Drain Charge	Q _{GD}				12.7			
Plateau Voltage	V _{GP}				2.8			
SWITCHING CHARACTERISTICS (Note 5	5)	• •		-				
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 30 V, I _D = 50 A, R _G = 2.5 Ω			21.8		ns	
Rise Time	tr				79.1			
Turn-Off Delay Time	t _{d(OFF)}				57.8			
Fall Time	t _f				81.3			
DRAIN-SOURCE DIODE CHARACTERISTICS								
Forward Diode Voltage	V _{SD}	VGS - 0 V,	$T_J = 25^{\circ}C$		0.78	1.2		
			T _J = 125°C		0.64		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			98			
Charge Time	t _a				45		ns	
Discharge Time	t _b				53		1	
Reverse Recovery Charge	Q _{RR}				190		nC	

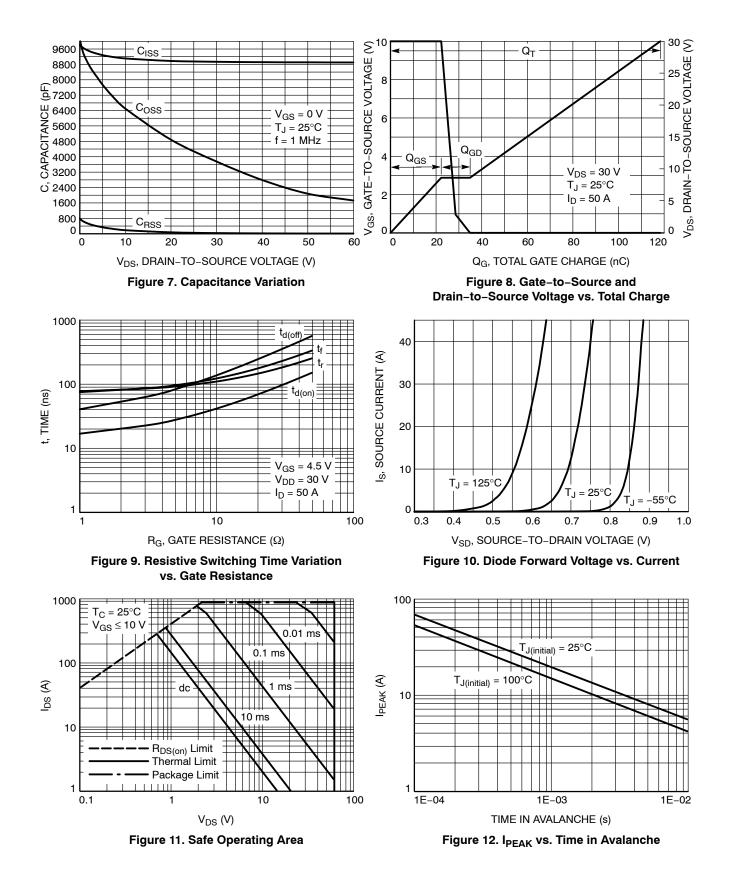
 $\begin{array}{ll} \mbox{4. Pulse Test: pulse width } \le 300 \ \mu \mbox{s, duty cycle } \le 2 \mbox{\%}. \\ \mbox{5. Switching characteristics are independent of operating junction temperatures.} \end{array}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



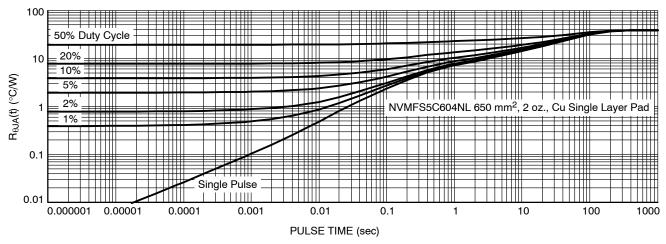


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C604NLT1G	5C604L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C604NLWFT1G	604LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C604NLT3G	5C604L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C604NLWFT3G	604LWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C604NLAFT1G	5C604L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C604NLWFAFT1G	604LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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